

National Semiconductor

DS90UR241Q DS90UR124Q

5-43 MHz DC-Balanced 24-Bit FPD-Link II Serializer and Deserializer Chipset

General Description

The DS90UR241/124 Chipset translates a 24-bit parallel bus into a fully transparent data/control FPD-Link II LVDS serial stream with embedded clock information. This chipset is ideally suited for driving graphical data to displays requiring 18bit color depth - RGB666 + HS, VS, DE + 3 additional general purpose data channels. This single serial stream simplifies transferring a 24-bit bus over PCB traces and cable by eliminating the skew problems between parallel data and clock paths. It saves system cost by narrowing data paths that in turn reduce PCB layers, cable width, and connector size and pins.

The DS90UR241/124 incorporates FPD-Link II LVDS signaling on the high-speed I/O. FPD-Link II LVDS provides a low power and low noise environment for reliably transferring data over a serial transmission path. By optimizing the Serializer output edge rate for the operating frequency range EMI is further reduced.

In addition, the device features pre-emphasis to boost signals over longer distances using lossy cables. Internal DC balanced encoding/decoding is used to support AC-Coupled interconnects. Using National Semiconductor's proprietary random lock, the Serializer's parallel data are randomized to the Deserializer without the need of REFCLK.

Features

- Supports displays with 18-bit color depth
- 5MHz to 43MHz pixel clock
- Automotive grade product AEC-Q100 grade 2 qualified

- 24:1 interface compression
- Embedded clock with DC Balancing supports AC-coupled data transmission
- Capable to drive up to 10 meters shielded twisted-pair cable
- No reference clock required (deserializer)
- Meets ISO 10605 ESD Greater than 8 kV HBM ESD structure
- Hot plug support
- EMI Reduction Serializer accepts spread spectrum input; data randomization and shuffling on serial link; Deserializer provides Adjustable PTO (progressive turnon) LVCMOS outputs
- @Speed BIST (built-in self test) to validate LVDS transmission path
- Individual power-down controls for both Transmitter and Receiver
- Power supply range 3.3V ± 10%
- 48-pin TQFP package for Transmitter and 64-pin TQFP package for Receiver
- Temperature range -40°C to +105°C
- Backward compatible mode with DS90C241/DS90C124

Applications

- Automotive Central Information Display
- Automotive Instrument Cluster Display
- Automotive Heads-Up Display
- Remote Camera-based Driver Assistance Systems

Applications Diagram



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Block Diagram VODSEL PRE DEN RAOFF REN DC Balance Encoder DC Balance Decoder R_{IN}+ D_{OUT}+ Parallel to Serial Serial to Parallel Output Latch Input Latch 24 24 ş D_{IN}-→ R_{OUT} R_T = 1002 -D^{OD_-} R^{IN} 001 TRFB . П Ł Timing PLL TCLK-PLL RAOFF and - LOCK RRFB Control RPWDNB BISTEN Timing BISTM Clock TPWDNB · and RCLK SLEW Recovery Control PTOSEL PASS SERIALIZER - DS90UR241 DESERIALIZER - DS90UR124 20194501

Ordering Information

NSID	Package Type	Package ID	Quantity
DS90UR241QVS	48-Lead TQFP style, 7.0 X 7.0 X 1.0 mm, 0.5 mm pitch	VBC48A	
DS90UR241QVSX	48-Lead TQFP style, 7.0 X 7.0 X 1.0 mm, 0.5 mm pitch	VBC48A	1000
DS90UR241IVS	48-Lead TQFP style, 7.0 X 7.0 X 1.0 mm, 0.5 mm pitch	VBC48A	
DS90UR241IVSX	48-Lead TQFP style, 7.0 X 7.0 X 1.0 mm, 0.5 mm pitch	VBC48A	1000
DS90UR124QVS	64-Lead TQFP style, 10.0 X 10.0 X 1.0 mm, 0.5 mm pitch	VEC64A	
DS90UR124QVSX	64-Lead TQFP style, 10.0 X 10.0 X 1.0 mm, 0.5 mm pitch	VEC64A	1000
DS90UR124IVS	64-Lead TQFP style, 10.0 X 10.0 X 1.0 mm, 0.5 mm pitch	VEC64A	
DS90UR124IVSX	64-Lead TQFP style, 10.0 X 10.0 X 1.0 mm, 0.5 mm pitch	VEC64A	1000

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{DD})	–0.3V to +4V
LVCMOS Input Voltage	–0.3V to (V _{DD} +0.3V)
LVCMOS Output Voltage	–0.3V to (V _{DD} +0.3V)
LVDS Receiver Input Voltage	-0.3V to +3.9V
LVDS Driver Output Voltage	-0.3V to +3.9V
LVDS Output Short Circuit Durat	ion 10 ms
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Temperature	
(Soldering, 4 seconds)	+260°C
Maximum Package Power Dissip	bation Capacity (<i>Note 2</i>)
Package De-rating:	$1/\theta_{JA}$ °C/W above +25°C
DS90UR241 – 48L TQFP	
θ_{JA}	45.8 (4L*); 75.4 (2L*) °C/W
θ _{JC}	21.0°C/W
DS90UR124 – 64L TQFP	
θ_{JA}	42.8 (4L*); 67.2 (2L*)°C/W
θ_{JC}	14.6°C/W

ESD Rating (HBM)	≥±8 kV
ESD Rating (ISO10605)	R _D = 2 kΩ, C _S = 330 pF
Contact Discharge (D _{OUT+} , D _{OUT-})	±10 kV
Air Discharge (D _{OUT+} , D _{OUT-})	±30 kV
Contact Discharge (R _{IN+} , R _{IN-})	±10 kV
Air Discharge (R _{IN+} , R _{IN-})	±30 kV

Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage (V _{DD})	3.0	3.3	3.6	V
Operating Free Air				
Temperature (T _A)	-40	+25	+105	°C
Clock Rate	5		43	MHz
Supply Noise			±100	mV _{P-P}

Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Pin/Freq.	Min	Тур	Max	Units		
LVCMOS DC SPECIFICATIONS									
VIH	High Level Input Voltage		Tx: D _{IN} [0:23], TCLK,	2.0		V_{DD}	V		
VIL	Low Level Input Voltage		TPWDNB, DEN, TRFB,	GND		0.8	V		
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA	RAOFF, VODSEL, RES0. Rx: RPWDNB, RRFB, REN, PTOSEL, BISTEN, BISTM, SLEW, RES0.		-0.8	-1.5	V		
I _{IN}	Input Current	V _{IN} = 0V or 3.6V	Tx: D _{IN} [0:23], TCLK, TPWDNB, DEN, TRFB, RAOFF, RES0. Rx: RRFB, REN, PTOSEL, BISTEN, BISTM, SLEW, RES0.	-10	±2	+10	μA		
			Rx: RPWDNB	-20	±5	+20	μA		
V _{OH}	High Level Output Voltage	$I_{OH} = -2 \text{ mA, SLEW} = L$ $I_{OH} = -4 \text{ mA, SLEW} = H$	Rx: R _{OUT} [0:23], RCLK, LOCK, PASS.	2.3	3.0	V_{DD}	v		
V _{OL}	Low Level Output Voltage	I _{OL} = +2 mA, SLEW = L I _{OL} = +4 mA, SLEW = H		GND	0.33	0.5	V		
I _{os}	Output Short Circuit Current	$V_{OUT} = 0V$		-40	-70	-110	mA		
I _{oz}	TRI-STATE [®] Output Current	RPWDNB, REN = 0V, $V_{OUT} = 0V$ or V_{DD}	Rx: R _{OUT} [0:23], RCLK, LOCK, PASS.	-30	±0.4	+30	μA		

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		Condition	IS	Pin/Freq.	MIN	тур	мах	Units
	SPECIFICATIONS							
V _{TH}	Voltage	V _{CM} = +1.8V		Rx: R _{IN+} , R _{IN-}			+50	mV
V_{TL}	Differential Threshold Low Voltage				-50			mV
I _{IN}	Input Current	$V_{IN} = +2.4V, V_{DD} = 3.6V$	V			±100	±250	μA
		$V_{\rm IN}=0V, \ V_{\rm DD}=3.6V$	1			±100	±250	μA
V_{OD}	Output Differential Voltage	$R_L = 100\Omega$, w/o pre-	VODSEL = L	Tx: D _{OUT+} , D _{OUT-}	380	500	630	mV
	(D _{OUT+})–(D _{OUT})	emphasis (Figure 10)	VODSEL = H		500	900	1100	
ΔV_{OD}	Output Differential Voltage Unbalance	R _L = 100Ω, w/o pre-emphasis	VODSEL = L VODSEL = H			1	50	mV
V _{OS}	Offset Voltage	R _L = 100Ω, w/o pre-emphasis	VODSEL = L VODSEL = H		1.00	1.25	1.50	v
ΔV_{OS}	Offset Voltage Unbalance	$R_L = 100\Omega$, w/o pre-emphasis	VODSEL = L			3	50	mV
	Output Short Circuit Current	$D_{OUT} = 0V$, $D_{IN} = H$.	VODSEL = L		-2.0	-5.0	-8.0	
03		TPWDNB = $2.4V$	VODSEL = H		-4.5	-7.9	-14.0	mA
I _{oz}	TRI-STATE Output Current	TPWDNB = 0V, D _{OUT} = 0V OR V _{DD}	1	•	-15	±1	+15	μA
		$TPWDNB = 2.4V, DEN = 0V$ $D_{OUT} = 0V OR V_{DD}$			-15	±1	+15	μA
		TPWDNB = 2.4V, DEN = 2.4V, $D_{OUT} = 0V \text{ OR } V_{DD}$ NO LOCK (NO TCLK)			-15	±1	+15	μA
SER/DES	SUPPLY CURRENT (DVDD*,	PVDD* AND AVDD* PI	NS) *DIGITAL,	PLL, AND ANALOG VI	DDS			<u> </u>
I _{DDT}	Serializer	$R_L = 100\Omega$, PRE = OFF	,	f = 43 MHz,		60	85	mA
	(includes load current)	RAOFF = H, VODSEL	= L	Pattern (Figure 1)				
		$R_L = 100\Omega$, PRE = 12 RAOFF = H, VODSEL	κΩ, = L			65	90	mA
		$R_L = 100\Omega$, PRE = OFF RAOFF = H, VODSEL	=, = H	f = 43 MHz, RANDOM pattern		66	90	mA
I _{DDTZ}	Serializer	TPWDNB = 0V					45	
	Supply Current Power-down	(All other LVCMOS Inp	uts = 0V)				45	μΑ
I _{DDR}	Deserializer Total Supply Current (includes load current)	$C_L = 4 \text{ pF},$ SLEW = H		f = 43 MHz, CHECKER BOARD Pattern LVCMOS Output <i>(Figure 2)</i>		85	105	mA
		C _L = 4 pF, SLEW = H		f = 43 MHz, RANDOM pattern LVCMOS Output		80	100	mA
I _{DDRZ}	Deserializer Supply Current Power-down	$\label{eq:RPWDNB} \begin{array}{l} RPWDNB = 0V \\ (All other LVCMOS Inputs = 0V, \\ R_{IN+}/R_{IN-} = 0V) \end{array}$					50	μA

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Serializer Input Timing Requirements for TCLK

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{TCP}	Transmit Clock Period	(Figure 5)	23.25	Т	200	ns
t _{TCIH}	Transmit Clock High Time		0.3T	0.5T	0.7T	ns
t _{TCIL}	Transmit Clock Low Time		0.3T	0.5T	0.7T	ns
t _{CLKT}	TCLK Input Transition Time	Figure 4, ((Note 9))		2.5		ns
t _{JIT}	TCLK Input Jitter	(Note 10)			±100	ps

Serializer Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{LLHT}	LVDS Low-to-High Transition Time	$R_L = 100\Omega$, VODSEL = L,		245	550	ps
t _{LHLT}	LVDS High-to-Low Transition Time	C _L = 10 pF to GND, <i>(Figure 3)</i>		264	550	ps
t _{DIS}	D _{IN} (0:23) Setup to TCLK	$R_{L} = 100\Omega, C_{L} = 10 \text{ pF to GND},$	4			ns
t _{DIH}	D _{IN} (0:23) Hold from TCLK	(Note 9), (Figure 5)	4			ns
t _{HZD}	D _{OUT} ± HIGH to TRI-STATE Delay	R _L = 100Ω,		10	15	ns
t _{LZD}	D _{OUT} ± LOW to TRI-STATE Delay	$C_L = 10 \text{ pF to GND},$		10	15	ns
t _{ZHD}	D _{OUT} ± TRI-STATE to HIGH Delay	(Note 6), (Figure 6)		75	150	ns
t _{zLD}	D _{OUT} ± TRI-STATE to LOW Delay]		75	150	ns
t _{PLD}	Serializer PLL Lock Time	R _L = 100Ω			10	ms
t _{SD}	Serializer Delay	$R_L = 100\Omega$, PRE = OFF, RAOFF = L, TRFB = H, (<i>Figure 8</i>)	3.5T+2		3.5T+10	ns
		R_L = 100Ω, PRE = OFF, RAOFF = L, TRFB = L, (<i>Figure 8</i>)	3.5T+2		3.5T+10	ns
TxOUT_E_O	TxOUT_Eye_Opening. TxOUT_E_O centered on (tBIT/)2	5 MHz–43 MHz, $R_L = 100\Omega$, $C_L = 10$ pF to GND, RANDOM pattern (<i>Note 10</i> , <i>Note 11</i>), (<i>Note 14</i>) (<i>Figure 9</i>)	0.76	0.84		UI

Deserializer Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Pin/Freq.	Min	Тур	Max	Units
t _{RCP}	Receiver out Clock Period	t _{RCP} = t _{TCP} , PTOSEL = H	RCLK (Figure 15)	23.25	Т	200	ns
t _{RDC}	RCLK Duty Cycle	PTOSEL = H, SLEW = L		45	50	55	%
t _{CLH}	LV C MOS L ow-to- H igh Transition Time	$C_{L} = 4 \text{ pF}$ (lumped load),	R _{out} [0:23], RCLK, LOCK		1.5	2.5	ns
t _{CHL}	LV C MOS H igh-to- L ow Transition Time	SLEW = H (<i>Note 9</i>)			1.5	2.5	ns
t _{CLH}	LV C MOS Low-to-High Transition Time	$C_L = 4 \text{ pF}$ (lumped load),	R _{out} [0:23], RCLK, LOCK		2.0	3.5	ns
t _{CHL}	LV C MOS H igh-to- L ow Transition Time	SLEW = L (<i>Note 9</i>)			2.0	3.5	ns

Symbol	Parameter	Conditions	Pin/Freq.	Min	Тур	Max	Units
t _{ROS}	R _{OUT} (0:7) Setup Data to RCLK (Group 1)	PTOSEL = L, SLEW = H,	R _{OUT} [0:7]	(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROH}	R _{OUT} (0:7) Hold Data to RCLK (Group 1)	(Figure 16)		(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROS}	R _{OUT} (8:15) S etup Data to RCLK (Group 2)	PTOSEL = L, SLEW = H,	R _{OUT} [8:15], LOCK	(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROH}	R _{OUT} (8:15) Hold Data to RCLK (Group 2)	(Figure 16)		(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROS}	R _{OUT} (16:23) S etup Data to RCLK (Group 3)		R _{OUT} [16:23]	(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROH}	R _{OUT} (16:23) S etup Data to RCLK (Group 3)			(0.35)* t _{RCP}	(0.5*t _{RCP})–3 UI		ns
t _{ROS}	R _{OUT} (0:7) Setup Data to RCLK (Group 1)	PTOSEL = H, SLEW = H,	R _{OUT} [0:7]	(0.35)* t _{RCP}	(0.5*t _{RCP})–2 UI		ns
t _{ROH}	R _{OUT} (0:7) Hold Data to RCLK (Group 1)	(Figure 15)		(0.35)* t _{RCP}	(0.5*t _{RCP})+2 UI		ns
t _{ROS}	R _{OUT} (8:15) S etup Data to RCLK (Group 2)		R _{OUT} [8:15], LOCK	(0.35)* t _{RCP}	(0.5*t _{RCP})–1 UI		ns
t _{ROH}	R _{OUT} (8:15) Hold Data to RCLK (Group 2)			(0.35)* t _{RCP}	(0.5*t _{RCP})+1 UI		ns
t _{ROS}	R _{OUT} (16:23) S etup Data to RCLK (Group 3)		R _{OUT} [16:23]	(0.35)* t _{RCP}	(0.5*t _{RCP})+1 UI		ns
t _{ROH}	R _{OUT} (16:23) S etup Data to RCLK (Group 3)			(0.35)* t _{RCP}	(0.5*t _{RCP})–1 UI		ns
t _{HZR}	HIGH to TRI-STATE Delay	PTOSEL = H,	R _{OUT} [0:23],		3	10	ns
t _{LZR}	LOW to TRI-STATE Delay	(Figure 14)	RCLK, LOCK		3	10	ns
t _{ZHR}	TRI-STATE to H IGH Delay				3	10	ns
t _{ZLR}	TRI-STATE to LOW Delay				3	10	ns
t _{DD}	Deserializer Delay	PTOSEL = H, (<i>Figure 12</i>)	RCLK		[5+(5/56)]T+3.7	[5+(5/56)]T +8	ns
t _{DSR}	Deserializer PLL Lock Time	(Note 7, Note 9)	5 MHz			128k*T	ms
	from Powerdown		43 MHz			128k*T	ms
RxIN_TOL-L	Receiver INput TOLerance Left	(Note 8, Note 9), (Note 11) (Figure 17)	5 MHz–43 MHz			0.25	UI
RxIN_TOL-R	Receiver INput TOLerance Right	(Note 8),(Note 9, Note 11) (Figure 17)	5 MHz–43 MHz			0.25	UI

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions.

Note 2: 4L =4 layer PCB per JEDEC specification, 2L = 2 layer PCB per JEDEC specification.

Note 3: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 4: Typical values represent most likely parametric norms at V_{DD} = 3.3V, Ta = +25 degC, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

Note 5: Current into device pins is defined as positive. Current out of a device pin is defined as negative. Voltages are referenced to ground except VOD, ΔVOD, VTH and VTL which are differential voltages.

Note 6: When the Serializer output is at TRI-STATE the Deserializer will lose PLL lock. Resynchronization MUST occur before data transfer.

Note 7: t_{DSR} is the time required by the Deserializer to obtain lock when exiting powerdown mode.

Note 8: RxIN_TOL is a measure of how much phase noise (jitter) the Deserializer can tolerate in the incoming data stream before bit errors occur. It is a measurement in reference with the ideal bit position, please see National's AN-1217 for detail.

Note 9: Specification is guaranteed by characterization and is not tested in production.

Note 10: t_{JIT} (@BER of 10e-9) specifies the allowable jitter on TCLK. t_{JIT} not included in TxOUT_E_O parameter.

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Note 11: UI – Unit Interval, equivalent to one ideal serialized data bit width. The UI scales with frequency. Note 12: Figures 1, 2 Figures 8, 12, 14show a falling edge data strobe (TCLK IN/RCLK OUT). Note 13: Figures 5, 15, 16 show a rising edge data strobe (TCLK IN/RCLK OUT). Note 14: TxOUT_E_O is affected by pre-emphasis value.

AC Timing Diagrams and Test Circuits



FIGURE 1. Serializer Input Checkerboard Pattern







FIGURE 3. Serializer LVDS Output Load and Transition Times













Group 1 will be latched internally by sequence of (early 2UI, late 1UI, early 1UI, late 2UI) Group 2 will be latched internally by sequence of (late 1UI, early 1UI, late 2UI, early 2UI) Group 3 will be latched internally by sequence of (early 1UI, late 2UI, early 2UI, late 1UI)



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RxIN_TOL_L is the ideal noise margin on the left of the figure, with respect to ideal. RxIN_TOL_R is the ideal noise margin on the right of the figure, with respect to ideal.



DS90UR241 Pin Diagram



Pin #	Pin Name	I/O/PWR	Description
CONT	ROL AND CON	FIGURATION	PINS
9	TPWDNB	LVCMOS_I	Transmitter Power Down Bar TPWDNB = H; Transmitter is Enabled and ON TPWDNB = L; Transmitter is in power down mode (Sleep), LVDS Driver D _{OUT} (+/-) Outputs are in TRI-STATE stand-by mode, PLL is shutdown to minimize power consumption.
24	VODSEL	LVCMOS_I	VOD Level SelectVODSEL = L; LVDS Driver Output is $\pm 500 \text{ mV}$ (R _L = 100Ω)VODSEL = H; LVDS Driver Output is $\pm 900 \text{ mV}$ (R _L = 100Ω)For normal applications, set this pin LOW. For long cable applications where a larger VOD isrequired, set this pin HIGH.
18	DEN	LVCMOS_I	Transmitter Data Enable DEN = H; LVDS Driver Outputs are Enabled (ON). DEN = L; LVDS Driver Outputs are Disabled (OFF), Transmitter LVDS Driver D _{OUT} (+/-) Outputs are in TRI-STATE, PLL still operational and locked to TCLK.
23	PRE	LVCMOS_I	$\label{eq:Pre-emphasis} \begin{array}{l} \mbox{Pre-emphasis Level Select} \\ \mbox{PRE} = \mbox{NC (No Connect); Pre-emphasis is Disabled (OFF).} \\ \mbox{Pre-emphasis is active when input is tied to VSS through external resistor R_{PRE}. Resistor value determines pre-emphasis level. Recommended value $R_{PRE} \geq 6 \ k\Omega; \ I_{max} = [48 \ / \ R_{PRE}], $R_{PREmin} = 6 \ k\Omega$ \end{array}$
11	TRFB	LVCMOS_I	Transmitter Clock Edge Select Pin TRFB = H; Parallel Interface Data is strobed on the Rising Clock Edge. TRFB = L; Parallel Interface Data is strobed on the Falling Clock Edge
12	RAOFF	LVCMOS_I	Randomizer Control Input Pin RAOFF = H, Backwards compatible mode for use with DS90 C 124 Deserializer. RAOFF = L; Additional randomization ON (Default), Selects 2E7 LSFR setting. See Table 1 for more details.
5, 8, 13	RES0	LVCMOS_I	Reserved. This pin MUST be tied LOW.
LVDS	SERIAL INTER		
20	D _{OUT+}	LVDS_O	Transmitter LVDS True (+) Output. This output is intended to be loaded with a 100 Ω load to the D _{OUT+} pin. The interconnect should be AC Coupled to this pin with a 100 nF capacitor.
19	D _{OUT-}	LVDS_O	Transmitter LVDS Inverted (-) Output This output is intended to be loaded with a 100 Ω load to the D _{OUT} pin. The interconnect should be AC Coupled to this pin with a 100 nF capacitor.
POWE	R / GROUND F	PINS	
	VDD	VDD	Analog Voltage Supply, LVDS Output POWER
21	VSS	GND	Analog Ground, LVDS Output GROUND
16	VDD	VDD	Analog Voltage Supply, VCO POWER
$\frac{1}{14}$	VSS		Analog Ground, VCO GROUND
14			
30			Digital Voltage Supply Serializer POWER
31	VSS	GND	Digital Ground Serializer GBOUND
7			Digital Voltage Supply, Serializer Logic POWER
6	VSS	GND	Digital Ground. Serializer Logic GROUND
42	VDD	VDD	Digital Voltage Supply, Serializer INPUT POWER
43	VSS	GND	Digital Ground, Serializer Input GROUND
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Pin #	Pin Name	I/O/PWR	Description			
49	PTOSEL	LVCMOS_I	Progressive Turn On Operation Selection			
			$PTO = H; R_{OUT}[23:0]$ are grouped into three groups of eight, with each group switching about			
			±1 UI to ±2 UI apart relative to RCLK. (Figure 15)			
			$ FIU = L; FIU$ Spread Mode, $R_{OUT}[23:0]$ outputs are spread ±1 UI to ±2 UI and RCLK spreat +1 UI (<i>Figure 16</i>) See Applications Informations section for more details			
63	BAOEE		ET 01. (<i>Figure 10</i>) See Applications informations section for more details.			
05	NAON		Randomizer Control input Pin (see Table 2 for more details.) RAOFE = H. Backwards compatible mode for use with $DS90C241$ Serializer.			
			RAOFF = L; Additional randomization ON (Default), Selects 2E7 LSFR setting.			
64	SLEW	LVCMOS_I	LVCMOS Output Slew Rate Control			
			SLEW = L; Low drive output at 2 mA (default)			
			SLEW = H; High drive output at 4 mA			
23	LOCK	LVCMOS_O	LOCK indicates the status of the receiver PLL			
		LOCK = H; receiver PLL IS locked				
50	BESO		Beserved This nin MIIST be tied I OW			
1-6	RESO		No Connection Pins are not physically connected to the dia Recommendation is to leave pin			
17, 18,	TIL OU		open or tie it to LOW.			
33, 34						
BIST M	ODE PINS(See	Applications Ir	formations section for more details.)			
61	BISTEN	LVCMOS_I	Control Pin for BIST Mode Enable			
			BISTEN = L; Default at Low, Normal Mode.			
			BISTEN = H; BIST mode active. When BISTEN = H and DS90UR241 DIN[23:0] = Low or			
62	RISTM		Floating; device will go to BIST mode accordingly. Check PASS output pin for test status.			
02	DISTIVI		BIST mode selection. Control pin for which beschallzer is set to BIST reporting mode.			
			BISTM = E; $Boliant at 2007, Catalo of at 1000 mitrospective bit of of option by option basisBISTM = H: Total accumulated bit error count provided on ROUT[7:0] (binary counter up to 255)$			
45	PASS	LVCMOS_O	Pass flag output for @Speed BIST Test operation.			
			PASS = L; BIST failure			
			PASS = H; LOCK = H before BIST can be enabled, then $1x10^{-9}$ error rate achieved across link.			
LVDS	SERIAL INTER	FACE PINS				
53	R _{IN+}	LVDS_I	Receiver LVDS True (+) Input — This input is intended to be terminated with a 100Ω load to			
			the R _{IN+} pin. The interconnect should be AC Coupled to this pin with a 100 nF capacitor.			
54	R _{IN-}	LVDS_I	Receiver LVDS Inverted (-) Input — This input is intended to be terminated with a 100Ω load			
			to the R _{IN-} pin. The interconnect should be AC Coupled to this pin with a 100 hF capacitor.			
POWE			Anolog LVDC Veltage Supply DOWED			
51						
50						
58	VSS	GND	Analog Voltage Supply, PLL POWER			
57						
56	VSS	GND				
32			Digital Voltage Supply LOGIC POWER			
31	VSS	GND	Digital Ground, Logic GBOUND			
46	VDD	VDD	Digital Voltage Supply, LOGIC POWER			
47	VSS	GND	Digital Ground, LOGIC GROUND			
40	VDD	VDD	Digital Voltage Supply, LVCMOS Output POWER			
39	VSS	GND	Digital Ground, LVCMOS Output GROUND			
26	VDD	VDD	Digital Voltage Supply, LVCMOS Output POWER			
25	VSS	GND	Digital Ground, LVCMOS Output GROUND			
11	VDD	VDD	Digital Voltage Supply, LVCMOS Output POWER			
12	VSS	GND	Digital Ground, LVCMOS Output GROUND			

Functional Description

The DS90UR241 Serializer and DS90UR124 Deserializer chipset is an easy-to-use transmitter and receiver pair that sends 24-bits of parallel LVCMOS data over a single serial LVDS link from 120 Mbps to 1.03 Gbps throughput. The DS90UR241 transforms a 24-bit wide parallel LVCMOS data into a single high speed LVDS serial data stream with embedded clock and scrambles / DC Balances the data to enhance signal quality to support AC coupling. The DS90UR124 receives the LVDS serial data stream and converts it back into a 24-bit wide parallel data and recovered clock. The 24-bit Serializer/Deserializer chipset is designed to transmit data up to 10 meters over shielded twisted pair (STP) at clock speeds from 5 MHz to 43MHz.

The Deserializer can attain lock to a data stream without the use of a separate reference clock source; greatly simplifying system complexity and overall cost. The Deserializer synchronizes to the Serializer regardless of data pattern, delivering true automatic "plug and lock" performance. It will lock to the incoming serial stream without the need of special training patterns or sync characters. The Deserializer recovers the clock and data by extracting the embedded clock information and validating data integrity from the incoming data stream and then deserializes the data. The Deserializer monitors the incoming clock information, determines lock status, and asserts the LOCK output high when lock occurs.

In addition the Deserializer also supports an optional @SPEED BIST (Built In Self Test) mode, BIST error flag, and LOCK status reporting pin. Signal quality on the wide parallel output is controlled by the SLEW control and bank slew (PTOSEL) inputs to help reduce noise and system EMI. Each device has a power down control to enable efficient operation in various applications.

INITIALIZATION AND LOCKING MECHANISM

Initialization of the DS90UR241 and DS90UR124 must be established before each device sends or receives data. Initialization refers to synchronizing the Serializer's and Deserializer's PLL's together. After the Serializers locks to the input clock source, the Deserializer synchronizes to the Serializers as the second and final initialization step.

Step 1: When V_{DD} is applied to both Serializer and/or Deserializer, the respective outputs are held in TRI-STATE and internal circuitry is disabled by on-chip power-on circuitry. When V_{DD} reaches V_{DD} OK (~2.2V) the PLL in Serializer begins locking to a clock input. For the Serializer, the local clock is the transmit clock, TCLK. The Serializer outputs are held in TRI-STATE while the PLL locks to the TCLK. After locking to TCLK, the Serializer output will remain in TRI-STATE while its PLL locks to the embedded clock information in serial data stream. Also, the Deserializer LOCK output will remain low until its PLL locks to incoming data and sync-pattern on the RIN± pins.

Step 2: The Deserializer PLL acquires lock to a data stream without requiring the Serializer to send special patterns. The Serializer that is generating the stream to the Deserializer will automatically send random (non-repetitive) data patterns during this step of the Initialization State. The Deserializer will lock onto embedded clock within the specified amount of time. An embedded clock and data recovery (CDR) circuit locks to the incoming bit stream to recover the high-speed receive bit clock and re-time incoming data. The CDR circuit expects a coded input bit stream. In order for the Deserializer to lock to a random data stream from the Serializer, it performs a series

of operations to identify the rising clock edge and validates data integrity, then locks to it. Because this locking procedure is independent on the data pattern, total random locking duration may vary. At the point when the Deserializer's CDR locks to the embedded clock, the LOCK pin goes high and valid RCLK/data appears on the outputs. Note that the LOCK signal is synchronous to valid data appearing on the outputs. The Deserializer's LOCK pin is a convenient way to ensure data integrity is achieved on receiver side.

DATA TRANSFER

After Serializer lock is established, the inputs DIN0– DIN23 are used to input data to the Serializer. Data is clocked into the Serializer by the TCLK input. The edge of TCLK used to strobe the data is selectable via the TRFB pin. TRFB high selects the rising edge for clocking data and low selects the falling edge. The Serializer outputs (DOUT±) are intended to drive point-to-point connections.

CLK1, CLK0, DCA, DCB are four overhead bits transmitted along the single LVDS serial data stream (*Figure 21*). The CLK1 bit is always high and the CLK0 bit is always low. The CLK1 and CLK0 bits function as the embedded clock bits in the serial stream. DCB functions as the DC Balance control bit. It does not require any pre-coding of data on transmit side. The DC Balance bit is used to minimize the short and longterm DC bias on the signal lines. This bit operates by selectively sending the data either unmodified or inverted. The DCA bit is used to validate data integrity in the embedded data stream. Both DCA and DCB coding schemes are integrated and automatically performed within Serializer and Deserializer.

The chipset supports clock frequency ranges of 5 MHz to 43 MHz. Every clock cycle, 24 databits are sent along with 4 additional overhead control bits. Thus the line rate is 1.20 Gbps maximum (140Mbps minimum). The link is extremely efficient at 86% (24/28). Twenty five (24 data + 1 clock) plus associated ground signals are reduced to only 1 single LVDS pair providing a compression ratio of better then 25 to 1.

In the serialized data stream, data/embedded clock & control bits (24+4 bits) are transmitted from the Serializer data output (DOUT±) at 28 times the TCLK frequency. For example, if TCLK is 43 MHz, the serial rate is $43 \times 28 = 1.20$ Giga bits per second. Since only 24 bits are from input data, the serial "payload" rate is 24 times the TCLK frequency. For instance, if TCLK = 43 MHz, the payload data rate is $43 \times 24 = 1.03$ Gbps. TCLK is provided by the data source and must be in the range of 5 MHz to 43 MHz nominal. The Serializer outputs (DOUT±) can drive a point-to-point connection as shown in *Figure 20*. The outputs transmit data when the enable pin (DEN) is high and TPWDNB is high. The DEN pin may be used to TRI-STATE the outputs when driven low.

When the Deserializer channel attains lock to the input from a Serializer, it drives its LOCK pin high and synchronously delivers valid data and recovered clock on the output. The Deserializer locks onto the embedded clock, uses it to generate multiple internal data strobes, and then drives the recovered clock to the RCLK pin. The recovered clock (RCLK output pin) is synchronous to the data on the ROUT[23:0] pins. While LOCK is high, data on ROUT[23:0] is valid. Otherwise, ROUT[23:0] is invalid. The polarity of the RCLK edge is controlled by the RRFB input. ROUT[23:0], LOCK and RCLK outputs will each drive a maximum of 4 pF load with a 43 MHz clock. REN controls TRI-STATE for ROUTn and the RCLK pin on the Deserializer.

RESYNCHRONIZATION

If the Deserializer loses lock, it will automatically try to re-establish lock. For example, if the embedded clock edge is not detected one time in succession, the PLL loses lock and the LOCK pin is driven low. The Deserializer then enters the operating mode where it tries to lock to a random data stream. It looks for the embedded clock edge, identifies it and then proceeds through the locking process.

The logic state of the LOCK signal indicates whether the data on ROUT is valid; when it is high, the data is valid. The system may monitor the LOCK pin to determine whether data on the ROUT is valid.

POWERDOWN

The Powerdown state is a low power sleep mode that the Serializer and Deserializer may use to reduce power when no data is being transferred. The TPWDNB and RPWDNB are used to set each device into power down mode, which reduces supply current to the µA range. The Serializer enters powerdown when the TPWDNB pin is driven low. In powerdown, the PLL stops and the outputs go into TRI-STATE, disabling load current and reducing current supply. To exit Powerdown, TPWDNB must be driven high. When the Serializer exits Powerdown, its PLL must lock to TCLK before it is ready for the Initialization state. The system must then allow time for Initialization before data transfer can begin. The Deserializer enters powerdown mode when RPWDNB is driven low. In powerdown mode, the PLL stops and the outputs enter TRI-STATE. To bring the Deserializer block out of the powerdown state, the system drives RPWDNB high.

Both the Serializer and Deserializer must reinitialize and relock before data can be transferred. The Deserializer will initialize and assert LOCK high when it is locked to the embedded clock.

TRI-STATE

For the Serializer, TRI-STATE is entered when the DEN or TPWDNB pin is driven low. This will TRI-STATE both driver output pins (DOUT+ and DOUT-). When DEN is driven high, the serializer will return to the previous state as long as all other control pins remain static (TPWDNB, TRFB).

When you drive the REN or RPWDNB pin low, the Deserializer enters TRI-STATE. Consequently, the receiver output pins (ROUT0–ROUT23) and RCLK will enter TRI-STATE. The LOCK output remains active, reflecting the state of the PLL. The Deserializer input pins are high impedance during receiver powerdown (RPWDNB low) and power-off ($V_{DD} =$ 0V).

PRE-EMPHASIS

The DS90UR241 features a Pre-Emphasis function used to compensate for long or lossy transmission media. Cable drive is enhanced with a user selectable Pre-Emphasis feature that provides additional output current during transitions to counteract cable loading effects. The transmission distance will be limited by the loss characteristics and quality of the media. Pre-Emphasis adds extra current during LVDS logic transition to reduce the cable loading effects and increase driving distance. In addition, Pre-Emphasis helps provide faster transitions, increased eye openings, and improved signal integrity. The ability of the DS90UR241 to use the Pre-Emphasis feature will extend the transmission distance up to 10 meters in most cases.

To enable the Pre-Emphasis function, the "PRE" pin requires one external resistor (Rpre) to Vss in order to set the additional current level. Values of Rpre should be between $6k\Omega$ and 100M Ω . Values less than $6k\Omega$ should not be used. A lower input resistor value on the "PRE" pin increases the magnitude of dynamic current during data transition. The additional source current is based on the following formula: PRE = (R_{PRE} \geq $6k\Omega$); I_{MAX} = [48 / R_{PRE}]. For example if Rpre = 15k\Omega, then the Pre-Emphasis current is increase by an additional 3.2 mA.

The amount of Pre-Emphasis for a given media will depend on the transmission distance of the application. In general, too much Pre-Emphasis can cause over or undershoot at the receiver input pins. This can result in excessive noise, crosstalk and increased power dissipation. For short cables or distances, Pre-Emphasis may not be required. Signal quality measurements are recommended to determine the proper amount of Pre-Emphasis for each application.

AC-COUPLING AND TERMINATION

The DS90UR241 and DS90UR124 supports AC-coupled interconnects through integrated DC balanced encoding/decoding scheme. To use the Serializer and Deserializer in an AC coupled application, insert external AC coupling capacitors in series in the LVDS signal path as illustrated in *Figure 20*. The Deserializer input stage is designed for AC-coupling by providing a built-in AC bias network which sets the internal V_{CM} to +1.8V. With AC signal coupling, capacitors provide the ac-coupling path to the signal input.

For the high-speed LVDS transmissions, the smallest available package should be used for the AC coupling capacitor. This will help minimize degradation of signal quality due to package parasitics. The most common used capacitor value for the interface is 100 nF (0.1 uF) capacitor. NPO class 1 or X7R class 2 type capacitors are recommended. 50 WVDC should be the minimum used for the best system-level ESD performance.

A termination resistor across DOUT \pm and RIN \pm is also required for proper operation to be obtained. The termination resistor should be equal to the differential impedance of the media being driven. This should be in the range of 90 to 132 Ohms. 100 Ohms is a typical value common used with standard 100 Ohm transmission media. This resistor is required for control of reflections and also completes the current loop. It should be placed as close to the Serializer DOUT \pm outputs and Deserializer RIN \pm inputs to minimize the stub length from the pins. To match with the deferential impedance on the transmission line, the LVDS I/O are terminated with 100 Ohm resistors on Serializer DOUT \pm outputs pins and Deserializer RIN \pm input pins.

Receiver Termination Option 1

A single 100 Ohm termination resistor is placed across the RIN \pm pins (see *Figure 20*). This provides the signal termination at the Receiver inputs. Other options may be used to increase noise tolerance.

Receiver Termination Option 2

For additional EMI tolerance, two 50 Ohm resistors may be used in place of the single 100 Ohm resistor. A small capacitor is tied from the center point of the 50 Ohm resistors to ground (see *Figure 22*). This provides a high-frequency low impedance path for noise suppression. Value is not critical, 4.7nF maybe used with general applications.

Receiver Termination Option 3

For high noise environments an additional voltage divider network may be connected to the center point. This has the advantage of a providing a DC low-impedance path for noise suppression. Use resistor values in the range of 100Ω -2K Ω

for the pullup and pulldown. Ratio the resistor values to bias the center point at 1.8V. For example (see *Figure 23*): V_{DD} =3.3V, Rpullup=1K Ω , Rpulldown=1.2K Ω ; or Rpullup=100 Ω , Rpulldown= 120 Ω (strongest). The smaller values will consume more bias current, but will provide enhanced noise suppression.

SIGNAL QUALITY ENHANCERS

The DS90UR124 Deserializer supports two signal quality enhancers. The SLEW pin is used to increase the drive strength of the LVCMOS outputs when driving heavy loads. SLEW allows output drive strength for high or low current drive. Default setting is LOW for low drive at 2 mA and HIGH for high drive at 4 mA.

There are two types of Progressive Turn-On modes (Fixed and PTO Frequency Spread) to help reduce EMI, simultaneous switching noise, and system ground bounce. The PTOSEL pin introduces bank skew in the data/clock outputs to limit the number of outputs switching simultaneously. For Fixed-PTO mode, the Deserializer ROUT[23:0] outputs are grouped into three groups of eight, with each group switching about 2 or 1 UI apart in phase from RCLK for Group 1 and Groups 2, 3 respectively (see *Figure 15*). In the PTO Frequency Spread mode, ROUT[23:0] are also grouped into three groups of eight, with each group is separated out of phase with the adjacent groups (see *Figure 16*) per every 4 cycles. Note that in the PTO Frequency Spread operating mode RCLK is also spreading and separated by 1 UI.

@SPEED-BIST TEST FEATURE

To assist vendors with test verification, the DS90UR241/ DS90UR124 is equipped with built-in self-test (BIST) capability to support both system manufacturing and field diagnostics. BIST mode is intended to check the entire high-speed serial link at full link-speed, without the use of specialized and expensive test equipment. This feature provides a simple method for a system host to perform diagnostic testing of both Serializer and Deserializer. The BIST function is easily configured through the 2 control pins on the DS90UR124. When the BIST mode is activated, the Serializer has the ability to transfer an internally generated PRBS data pattern. This pattern traverses across interconnecting links to the Deserializer. The DS90UR124 includes an on-chip PRBS pattern verification circuit that checks the data pattern for bit errors and reports any errors on the data output pins on the Deserializer. The @SPEED-BIST feature uses 2 signal pins (BISTEN and BISTM) on the DS90UR124 Deserializer. The BISTEN and BISTM pins together determine the functions of the BIST mode. The BISTEN signal (HIGH) activates the test feature on the Deserializer. After the BIST mode is enabled, all the data input channels DIN[23:0] on the DS90UR241 Serializer must be set logic LOW or floating in order for Deserializer to start accepting data. An input clock signal (TCLK) for the Serializer must also be applied during the entire BIST operation. The BISTM pin selects error reporting status mode of the BIST function. When BIST is configured in the error status mode (BISTM = LOW), each of the ROUT[23:0] outputs will correspond to bit errors on a cycle-by-cycle basis. The result of bit mismatches are indicated on the respective parallel inputs on the ROUT[23:0] data output pins. In the BIST errorcount accumulator mode (BISTM = HIGH), an 8-bit counter on ROUT[7:0] is used to represent the number of errors detected (0 to 255 max). The successful completion of the BIST test is reported on the PASS pin on the Deserializer. The Deserializer's PLL must first be locked to ensure the PASS status is valid. The PASS status pin will stay LOW and then transition to HIGH once a BER of 1×10^{-9} is achieved across the transmission link.

BACKWARDS COMPATIBLE MODE WITH DS90C241 AND DS90C124

The RAOFF pin allows a backward compatible mode with DS90C241/DS90C124 devices. To interface with either DS90C241 Serializer or DS90C124 Deserializer, the RAOFF pin on DS90UR241 or DS90UR124 must be tied HIGH to disable the additional LSFR coding. For normal operation directly with DS90UR241 to DS90UR124, RAOFF pins are set LOW. See *Table 1* and *Table 2* for more details.

Applications Information

USING THE DS90UR241 AND DS90UR124

The DS90UR241/DS90UR124 Serializer/Deserializer (SERDES) pair sends 24 bits of parallel LVCMOS data over a serial LVDS link up to 1.03 Gbps. Serialization of the input data is accomplished using an on-board PLL at the Serializer which embeds clock with the data. The Deserializer extracts the clock/control information from the incoming data stream and deserializes the data. The Deserializer monitors the incoming clock information to determine lock status and will indicate lock by asserting the LOCK output high.

DISPLAY APPLICATION

The DS90UR241/124 chipset is intended for interface between a host (graphics processor) and a Display. It supports an 18-bit color depth (RGB666) and up to 1280 X 480 display formats. In a RGB666 configuration 18 color bits (R[5:0], G [5:0], B[5:0]), Pixel Clock (PCLK) and three control bits (VS, HS and DE) along with three spare bits are supported across the serial link with PCLK rates from 5 to 43 MHz.

TYPICAL APPLICATION CONNECTION

Figure 18 shows a typical application of the DS90UR241 Serializer (SER). The LVDS outputs utilize a 100 ohm termination and 100nF coupling capacitors to the line. Bypass capacitors are placed near the power supply pins. At a minimum, three 0.1uF capacitors should be used for local bypassing. A system GPO (General Purpose Output) controls the TPWDNB pin. In this application the TRFB pin is tied High to latch data on the rising edge of the TCLK. The DEN signal is not used and is tied High also. The application is to the companion Deserializer (DS90UR124) so the RAOFF pin is tied low to scramble the data and improve link signal quality. In this application the link is typical, therefore the VODSEL pin is tied Low for the standard LVDS swing. The pre-emphasis input utilizes a resistor to ground to set the amount of pre-emphasis desired by the application.

*Figure 19*shows a typical application of the DS90UR124 Deserializer (DES). The LVDS inputs utilize a 100 ohm termination and 100nF coupling capacitors to the line. Bypass capacitors are placed near the power supply pins. At a minimum, four 0.1uF capacitors should be used for local bypassing. A system GPO (General Purpose Output) controls the RPWDNB pin. In this application the RRFB pin is tied High to strobe the data on the rising edge of the RCLK. The REN signal is not used and is tied High also. The application is to the companion Serializer (DS90UR241) so the RAOFF pin is tied low to descramble the data. Output (LVCMOS) signal quality is set by the SLEW pin, and the PTOSEL pin can be used to reduce simultaneous output switching by introducing a small amount of delay between output banks.



FIGURE 18. DS90UR241 Typical Application Connection

POWER CONSIDERATIONS

An all LVCMOS design of the Serializer and Deserializer makes them inherently low power devices. Additionally, the constant current source nature of the LVDS outputs minimize the slope of the speed vs. I_{DD} curve of LVCMOS designs.

NOISE MARGIN

The Deserializer noise margin is the amount of input jitter (phase noise) that the Deserializer can tolerate and still reliably recover data. Various environmental and systematic factors include:

Serializer: V_{DD} noise, TCLK jitter (noise bandwidth and out-of-band noise)

Media: ISI, V_{CM} noise

Deserializer: V_{DD} noise

For a graphical representation of noise margin, please see .

TRANSMISSION MEDIA

The Serializer and Deserializer are to be used in point-to-point configuration, through a PCB trace, or through twisted pair

cable. In a point-to-point configuration, the transmission media needs be terminated at both ends of the transmitter and receiver pair. Interconnect for LVDS typically has a differential impedance of 100 Ohms. Use cables and connectors that have matched differential impedance to minimize impedance discontinuities. In most applications that involve cables, the transmission distance will be determined on data rates involved, acceptable bit error rate and transmission medium.

LIVE LINK INSERTION

The Serializer and Deserializer devices support live pluggable applications. The automatic receiver lock to random data "plug & go" hot insertion capability allows the DS90UR124 to attain lock to the active data stream during a live insertion event.







PCB LAYOUT AND POWER SYSTEM CONSIDERATIONS

Circuit board layout and stack-up for the LVDS SERDES devices should be designed to provide low-noise power feed to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise pickup, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mils) for power / ground sandwiches. This arrangement provides plane capacitance for the PCB power system with low-inductance parasitics, which has proven especially effective at high frequencies, and makes the value and placement of external bypass capacitors less critical. Ex-

ternal bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01 uF to 0.1 uF. Tantalum capacitors may be in the 2.2 uF to 10 uF range. Voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

Surface mount capacitors are recommended due to their smaller parasitics. When using multiple capacitors per supply pin, locate the smaller value closer to the pin. A large bulk capacitor is recommend at the point of power entry. This is typically in the 50uF to 100uF range and will smooth low frequency switching noise. It is recommended to connect power

and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path.

A small body size X7R chip capacitor, such as 0603, is recommended for external bypass. Its small body size reduces the parasitic inductance of the capacitor. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20-30 MHz range. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter many be used to provide clean power to sensitive circuits such as PLLs.

Use at least a four layer board with a power and ground plane. Locate LVCMOS signals away from the LVDS lines to prevent coupling from the LVCMOS lines to the LVDS lines. Closelycoupled differential lines of 100 Ohms are typically recommended for LVDS interconnect. The closely coupled lines help to ensure that coupled noise will appear as commonmode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

Termination of the LVDS interconnect is required. For pointto-point applications, termination should be located at both ends of the devices. Nominal value is 100 Ohms to match the line's differential impedance. Place the resistor as close to the transmitter DOUT \pm outputs and receiver RIN \pm inputs as possible to minimize the resulting stub between the termination resistor and device.

LVDS INTERCONNECT GUIDELINES

See AN-1108 and AN-905 for full details.

- Use 100Ω coupled differential pairs
- Use the S/2S/3S rule in spacings
 - —S = space between the pair
 —2S = space between pairs
 —3S = space to LVCMOS signal
- -33 = space to EVCINOS sign
- Minimize the number of Vias
- Use differential connectors when operating above 500Mbps line speed
- Maintain balance of the traces
- Minimize skew within the pair
- Terminate as close to the TX outputs and RX inputs as possible

Additional general guidance can be found in the LVDS Owner's Manual - available in PDF format from the National web site at: www.national.com/lvds







Truth Tables

TABLE 1. DS90UR24	1 Serializer Truth Tabl	е
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TPWDNB (Pin 9)	DEN (Pin 18)	RAOFF (Pin 12)	Tx PLL Status (Internal)	LVDS Outputs (Pins 19 and 20)
L	X	Х	X	Hi Z
Н	L	Х	X	Hi Z
Н	н	Х	Not Locked	Hi Z
Н	Н	L	Locked	Serialized Data with Embedded Clock (DS90 UR 124 compatible)
Н	Н	Н	Locked Serialized Data with Embedded Clo (DS90 C 124 compatible)	

TABLE 2. DS90UR124 Deserializer Truth Table					
RPWDNB (Pin 48)	REN (Pin 60)	RAOFF (Pin 63)	Rx PLL Status (Internal)	ROUTn and RCLK (See Pin Diagram)	LOCK (Pin 23)
L	Х	X	Х	Hi Z	Hi Z
Н	L	X	Х	Hi Z	L = PLL Unocked; H = PLL Locked
Н	Н	X	Not Locked	Hi Z	L
Н	Н	L	Locked	Data and RCLK Active (DS90 UR 241 compatible)	Н
Н	Н	Н	Locked	Data and RCLK Active (DS90 C 241 compatible)	Н



Notes

Pr	oducts	Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns	
Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/greer	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage Reference	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Solutions	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic	
Wireless (PLL/VCO)	www.national.com/wireless	PowerWise® Design University	www.national.com/training	
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